SCES062G - DECEMBER 1995 - REVISED JUNE 1998

- Member of the Texas Instruments
 Widebus™ Family
- EPIC™ (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 2 V at V_{CC} = 3.3 V, T_A = 25°C
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- Power Off Disables Outputs, Permitting Live Insertion
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 16-bit (dual-octal) noninverting bus transceiver is designed for 1.65-V to 3.6-V V_{CC} operation.

The SN74LVC16245A is designed for asynchronous communication between data buses. The control-function implementation minimizes external timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can be used to disable the device so that the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

The SN74LVC16245A is characterized for operation from -40°C to 85°C.

DGG OR DL PACKAGE (TOP VIEW)

		,	
	П		
1DIR	1		10E
1B1	2		1A1
1B2	3] 1A2
GND L	4	45	GND
1B3	5		1A3
1B4 [6] 1A4
v _{cc} [7	42] v _{cc}
1B5 [8] 1A5
1B6 [9] 1A6
GND [10		GND
1B7 [11] 1A7
1B8 [12		1A8
2B1	13		2A1
2B2	14	35] 2A2
GND [15	34	GND
2B3	16	33	2A3
2B4 [17	32	2A4
v _{cc} [18	31] v _{cc}
2B5 [19	30] 2A5
2B6 [20	29	2A6
GND [21		GND
2B7 [22] 2A7
2B8 [23	26	2A8
2DIR [24	25	20E

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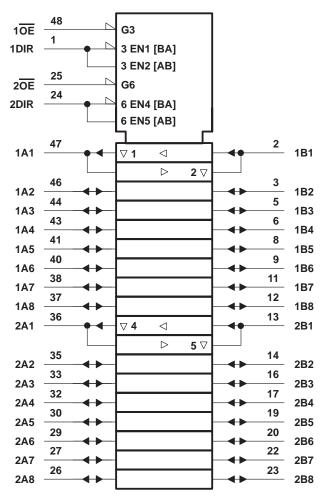
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FUNCTION TABLE (each 8-bit section)

INPUTS		OPERATION
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	X	Isolation

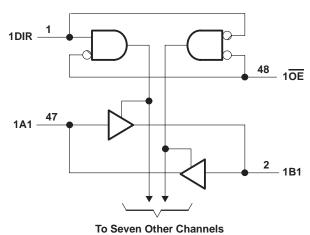
logic symbol†

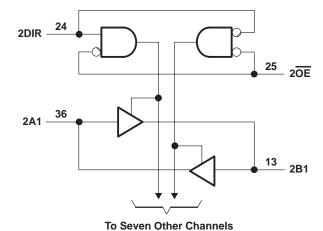


[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	–0.5 V to 6.5 V
Input voltage range, V _I : (see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high-impedance or power-off state, VO	
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, VO	
(see Notes 1 and 2)	0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Continuous output current, I _O	±50 mA
Continuous current through each V _{CC} or GND	±100 mA
Package thermal impedance, θ _{JA} (see Note 3): DGG package	89°C/W
DL package	94°C/W
Storage temperature range, T _{Stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The value of V_{CC} is provided in the recommended operating conditions table.
 - 3. The package thermal impedance is calculated in accordance with JESD 51.

SN74LVC16245A **16-BIT BUS TRANSCEIVER** WITH 3-STATE OUTPUTS SCES062G - DECEMBER 1995 - REVISED JUNE 1998

recommended operating conditions (see Note 4)

			MIN	MAX	UNIT			
\/00	Supply voltage	Operating	1.65	3.6	V			
VCC	Supply voltage	Data retention only	1.5		V			
		V _{CC} = 1.65 V to 1.95 V	0.65 × V _{CC}					
V_{IH}	High-level input voltage	V _{CC} = 2.3 V to 2.7 V	1.7		V			
		V _{CC} = 2.7 V to 3.6 V	2					
		V _{CC} = 1.65 V to 1.95 V		0.35 × V _{CC}				
V_{IL}	Low-level input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	V			
		V _{CC} = 2.7 V to 3.6 V		0.8				
٧ _I	Input voltage	•	0	5.5	V			
	Output valte as	High or low state	0	VCC	٧			
۷O	Output voltage	3 state	0	5.5				
I _{OH} Hiç		V _{CC} = 1.65 V		-4				
	High-level output current	V _{CC} = 2.3 V		-8				
		V _{CC} = 2.7 V		-12				
		V _{CC} = 3 V		-24				
		V _{CC} = 1.65 V		4				
1	Low-level output current	V _{CC} = 2.3 V		8	mA			
lOL		V _{CC} = 2.7 V		12	MA			
		V _{CC} = 3 V		24				
Δt/Δν	Input transition rise or fall rate	-	0	5	ns/V			
TA	Operating free-air temperature		-40	85	°C			

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CONDITION	Vcc	MIN	TYP [†]	MAX	UNIT	
		I _{OH} = -100 μA	1.65 V to 3.6 V	V _{CC} -0.2				
		I _{OH} = -4 mA	1.65 V	1.2				
V		I _{OH} = -8 mA	2.3 V	1.7			v	
VOH		I _{OH} = -12 mA		2.7 V	2.2			V
		IOH = -12 IIIA		3 V	2.4			
		I _{OH} = -24 mA	3 V	2.2				
		I _{OL} = 100 μA		1.65 V to 3.6 V			0.2	
		I _{OL} = 4 mA	1.65 V			0.45	- 1	
VOL		I _{OL} = 8 mA	2.3 V			0.7	V	
		I _{OL} = 12 mA	2.7 V			0.4		
		I _{OL} = 24 mA		3 V			0.55	
lį	Control inputs	V _I = 0 to 5.5 V		3.6 V			±5	μΑ
l _{off}		V _I or V _O = 5.5 V		0			±10	μΑ
loz‡		V _O = 0 to 5.5 V		3.6 V			±10	μΑ
		V _I = V _{CC} or GND		0.01/			20	
ICC		3.6 V ≤ V _I ≤ 5.5 V§	IO = 0	3.6 V	20		μΑ	
ΔlCC		One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND		2.7 V to 3.6 V			500	μΑ
Ci	Control inputs	V _I = V _{CC} or GND		3.3 V		5		pF
Cio	A or B ports	$V_O = V_{CC}$ or GND		3.3 V		7.5		pF

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 through 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
	(1141 01)	(0011 01)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
^t pd	A or B	B or A	¶	¶	¶	¶		4.7	1	4	ns
t _{en}	ŌE	A or B	¶	¶	¶	¶		6.7	1.5	5.5	ns
^t dis	ŌE	A or B	¶	¶	¶	¶		7.1	1.5	6.6	ns
tsk(o)#										1	ns

 $[\]P$ This information was not available at the time of publication.

operating characteristics, T_A = 25°C

PARAMETER			TEST CONDITIONS	V _{CC} = 1.8 V ± 0.15 V	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V	UNIT
		CONDITIONS	TYP	TYP	TYP		
Cara	Power dissipation capacitance	Outputs enabled	f = 10 MHz	¶	¶	38	pF
Popa	C _{pd} per transceiver	Outputs disabled	1 = 10 WHZ	¶	¶	4	pr

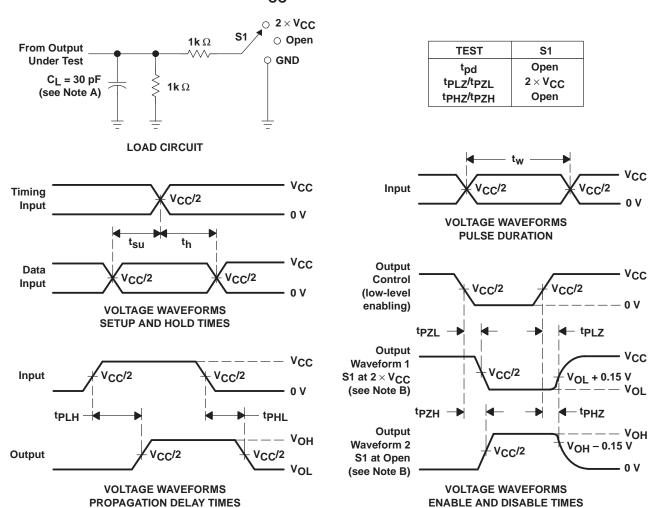
This information was not available at the time of publication.



[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. ‡ For I/O ports, the parameter I_{OZ} includes the input leakage current. § This applies in the disabled state only.

[#] Skew between any two outputs of the same package switching in the same direction

PARAMETER MEASUREMENT INFORMATION $V_{CC} = 1.8 \text{ V} \pm 0.15 \text{ V}$



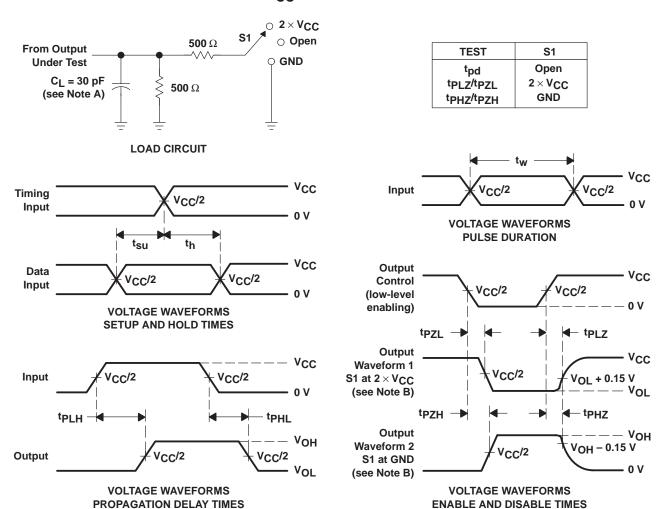
- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r \leq$ 2 ns. $t_f \leq$ 2 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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PARAMETER MEASUREMENT INFORMATION $V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$



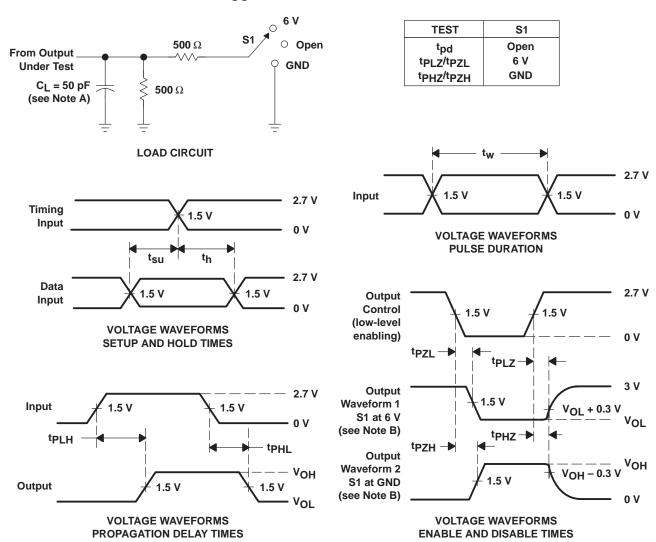
NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f \leq$ 2 ns. $t_f \leq$ 2 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms



PARAMETER MEASUREMENT INFORMATION V_{CC} = 2.7 V AND 3.3 V \pm 0.3 V



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpl 7 and tpH7 are the same as tdis.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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